ON Semiconductor

Is Now

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Linear Regulator - Low V_{IN}, Low Noise, High PSRR ²⁰⁰ mA

NCP110

The NCP110 is a linear regulator capable of supplying 200 mA output current from 1.1 V input voltage. The device provides wide output range from 0.6 V up to 4.0 V, very low noise and high PSRR. Due to low quiescent current the NCP110 is suitable for battery powered devices such as smartphones and tablets. The device is designed to work with a 1 μ F input and a 1 μ F output ceramic capacitor. It is available in ultra-small 0.35P, 0.64 mm x 0.64 mm Chip Scale Package (CSP) and XDFN4 0.65P, 1 mm x 1 mm.

Features

- Operating Input Voltage Range: 1.1 V to 5.5 V
- Available in Fixed Voltage Option: 0.6 V to 4.0 V
- ±2% Accuracy Over Load/Temperature
- Ultra Low Quiescent Current Typ. 20 µA
- Standby Current: Typ. 0.1 µA
- Very Low Dropout: 70 mV for 1.05 V @ 100 mA
- High PSRR: Typ. 95 dB at 20 mA, f = 1 kHz
- Ultra Low Noise: 8.8 μV_{RMS}
- Stable with a 1 µF Small Case Size Ceramic Capacitors
- Available in –WLCSP4 0.64mm x 0.64mm x 0.33mm Case 567VS
 –XDFN4 1mm x 1mm x 0.4mm Case 711AJ
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- Battery-powered Equipment
- Smartphone, Tablets
- Digital Cameras
- Smoke Detectors
- Portable Medical Equipment
- RF, PLL, VCO and Clock Power Supplies
- Battery Powered Wireless IoT Modules

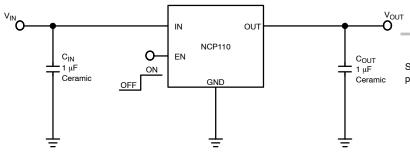
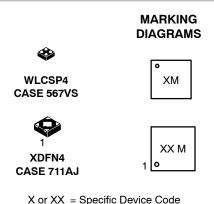


Figure 1. Typical Application Schematics



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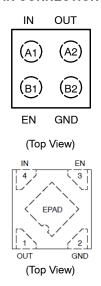
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PIN CONNECTIONS

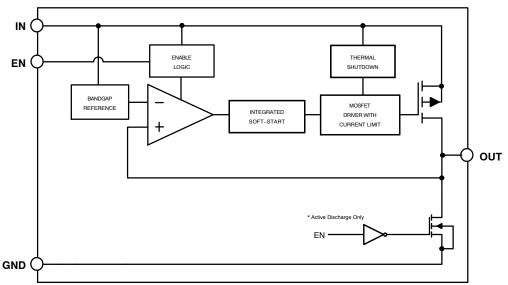
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ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 14 of this data sheet.





PIN FUNCTION DESCRIPTION

| Pin No. CSP4 | Pin No. XDFN4 | Pin Name | Description |
|-----------------|------------------|-------------|--|
| A1 | 4 | IN | Input voltage supply pin |
| A2 | 1 | OUT | Regulated output voltage. The output should be bypassed with small 1 μF ceramic capacitor. |
| B1 | 3 | EN | Chip enable: Applying V _{EN} < 0.2 V disables the regulator, Pulling V _{EN} > 0.7 V enables the LDO. |
| B2 | 2 | GND | Common ground connection |
| - | EPAD | EPAD | Expose pad can be tied to ground plane for better power dissipation |

ABSOLUTE MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|--------------------|---|------|
| Input Voltage (Note 1) | V _{IN} | –0.3 V to 6 | V |
| Output Voltage | V _{OUT} | –0.3 to V _{IN} + 0.3, max. 6 V | V |
| Chip Enable Input | V _{CE} | –0.3 to 6 V | V |
| Output Short Circuit Duration | tsc | unlimited | S |
| Maximum Junction Temperature | TJ | 150 | °C |
| Storage Temperature | T _{STG} | -55 to 150 | °C |
| ESD Capability, Human Body Model (Note 2) | ESD _{HBM} | 2000 | V |
| ESD Capability, Machine Model (Note 2) | ESD _{MM} | 200 | V |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Refer to ELECTRICAL CHARACTERISTICS and APPLICATION INFORMATION for Safe Operating Area.

2. This device series incorporates ESD protection and is tested by the following methods:

ESD Human Body Model tested per EIA/JESD22-A114

ESD Machine Model tested per EIA/JESD22-A115

Latchup Current Maximum Rating tested per JEDEC standard: JESD78.

THERMAL CHARACTERISTICS

| Rating | Symbol | Value | Unit |
|--|---------------|-------|------|
| Thermal Characteristics, CSP4 (Note 3) Thermal Resistance, Junction-to-Air | P | 108 | °C/W |
| Thermal Characteristics, XDFN4 (Note 3) Thermal Resistance, Junction-to-Air | $R_{	hetaJA}$ | 208 | 0/11 |

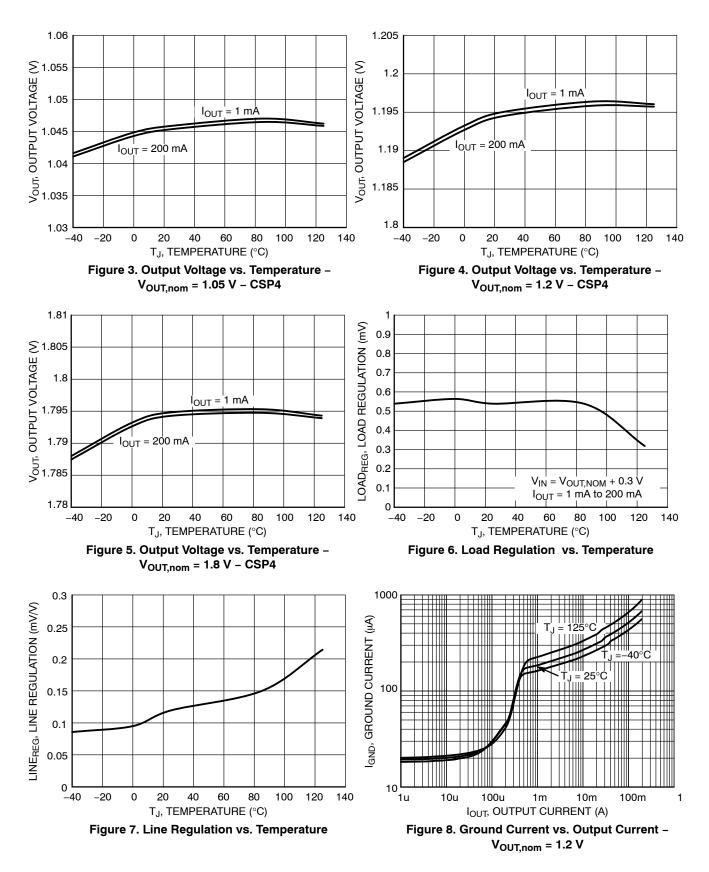
3. Measured according to JEDEC board specification. Detailed description of the board can be found in JESD51-7

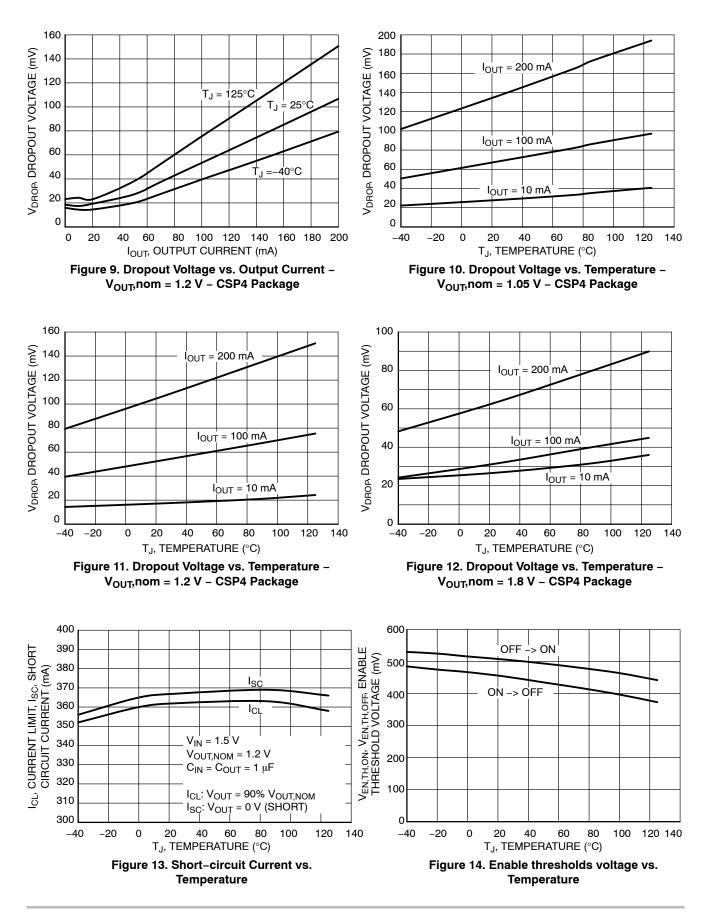
| Parameter | Test Conditions | | | Min | Тур | Max | Unit | |
|---|---|---|---------------------|-----|----------------------|---------------|------|--|
| Operating Input Voltage | | | V _{IN} | 1.1 | | 5.5 | V | |
| Output Voltage Accuracy | $V_{IN} = V_{OUT(NOM)} + 0.3 V$ | $V_{OUT(NOM)} \le 1.5 \text{ V}$ | V _{OUT} | -30 | | +30 | mV | |
| | $(V_{IN} \ge 1.1 V)$ | V _{OUT(NOM) >} 1.5 V | | -2 | | +2 | % | |
| Line Regulation | $V_{OUT(NOM)} + 0.5 \text{ V} \leq \text{V}_{\text{IN}} \leq$ | 5.5 V, (V _{IN} ≥ 1.1 V) | Line _{Reg} | | 0.02 | | %/V | |
| Load Regulation | I _{OUT} = 1 mA to | 200 mA | Load _{Reg} | | 0.001 | | %/mA | |
| Dropout Voltage (Note 5) | V _{OUT(NOM)} = 1.05 V | I _{OUT} = 50 mA | V _{DO} | | 40 | 70 | mV | |
| | | I _{OUT} = 100 mA | | | 70 | 130 | 1 | |
| | V _{OUT(NOM)} = 1.20 V | l _{OUT} = 110 mA | | | 60 | 140 | 1 | |
| | | I _{OUT} = 200 mA | | | 110 | 190 | 1 | |
| | V _{OUT(NOM)} = 1.80 V | I _{OUT} = 200 mA | | | 65 | 120 | | |
| | V _{OUT(NOM)} = 2.80 V | I _{OUT} = 200 mA | | | 45 | 100 | 1 | |
| Output Current Limit | V _{OUT} = 90% V _O | I _{CL} | 225 | 300 | | | | |
| Short Circuit Current | V _{OUT} = 0 | I _{SC} | | 300 | | mA | | |
| Quiescent Current | l _{OUT} = 0 n | ۱A | l _Q | | 20 | 25 | μA | |
| Shutdown Current | $V_{EN} \le 0.2 \text{ V}, \text{ V}_{IN}$ | = 1.1 V | I _{DIS} | | 0.01 | 1.0 | μΑ | |
| EN Pin Threshold Voltage | EN Input Volta | V _{ENH} | 0.7 | | | | | |
| | EN Input Volta | V _{ENL} | | | 0.2 | V | | |
| EN Pull Down Current | V _{EN} = 1.1 | V | I _{EN} | | 0.2 | 0.5 | μA | |
| Turn–On Time | C_{OUT} = 1 µF, From asso V_{OUT} = 95% V_{O} | ertion of V _{EN} to UT(NOM) | t _{ON} | | 120 | | μs | |
| Power Supply Rejection Ratio | | | PSRR | | 90 95 85 55 | | dB | |
| Output Voltage Noise | f = 10 Hz to 10 | V _N | | 8.8 | | μV_{RMS} | | |
| Thermal Shutdown Threshold | Temperature | T _{SDH} | | 160 | | °C | | |
| | Temperature | T _{SDL} | | 140 | | °C | | |
| Active Output Discharge Resis- tance | V _{EN} < 0.2 V, Version A only | | | | 280 | | Ω | |

| ELECTRICAL CHARACTERISTICS $-40^{\circ}C \le T_J \le 125^{\circ}C$; $V_{IN} = V_{OUT(NOM)} + 0.3$ V or 1.1 V, whichever is greater; $I_{OUT} = 1$ mA, $C_{IN} = 1$ mA, |
|---|
| $C_{OUT} = 1 \ \mu F$, unless otherwise noted. $V_{EN} = 1.0 \ V$. Typical values are at $T_{J} = +25^{\circ}C$ (Note 4). |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Performance guaranteed over the indicated operating temperature range by design and/or characterization. Production tested at $T_A = 25^{\circ}C$.

Commance guarances over the indicated operating temperature range by design and/or characterization. Production tested at T_A = Low duty cycle pulse techniques are used during the testing to maintain the junction temperature as close to ambient as possible.
 Dropout voltage is characterized when V_{OUT} falls 0.02 x V_{OUT(NOM)} below V_{OUT(NOM)}.
 Guaranteed by design.





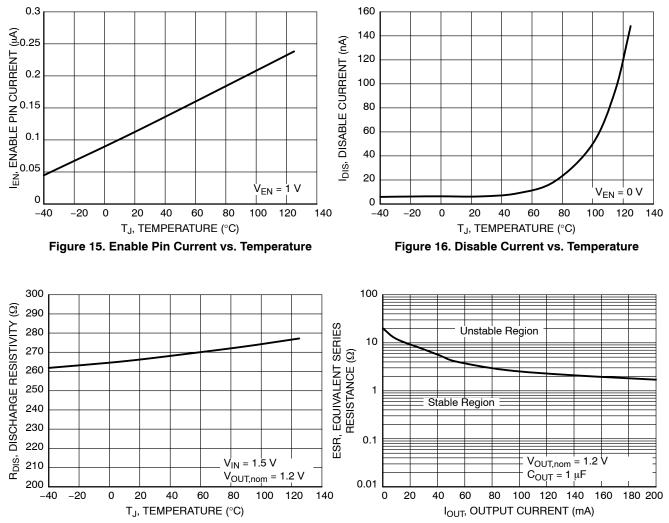


Figure 17. Discharge Resistivity vs. Temperature

Figure 18. Maximum C_{OUT} ESR Value vs. Output Current

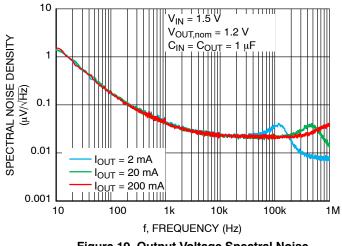


Figure 19. Output Voltage Spectral Noise Density vs. Frequency

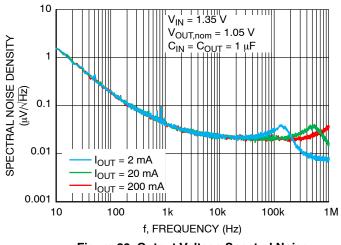
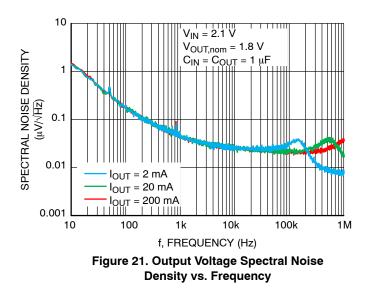


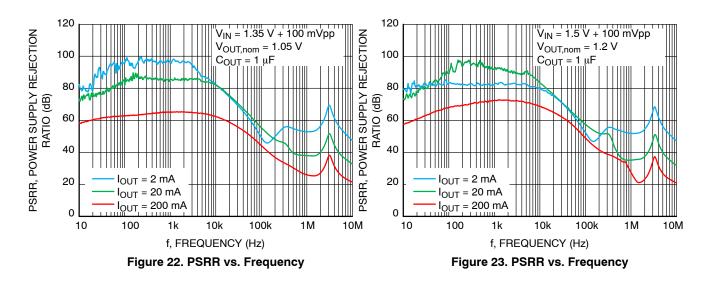
Figure 20. Output Voltage Spectral Noise Density vs. Frequency

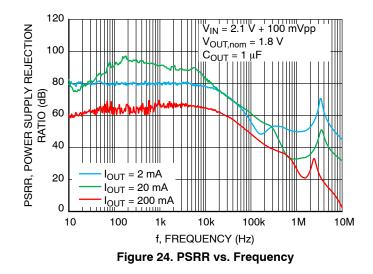


| I _{OUT} | RMS Output Noise (μV) | | | |
|------------------|-----------------------|------------------|--|--|
| (mA) | 10 Hz – 100 kHz | 100 Hz – 100 kHz | | |
| 2 | 10.01 | 8.79 | | |
| 20 | 8.78 | 7.39 | | |
| 200 | 8.77 | 7.44 | | |

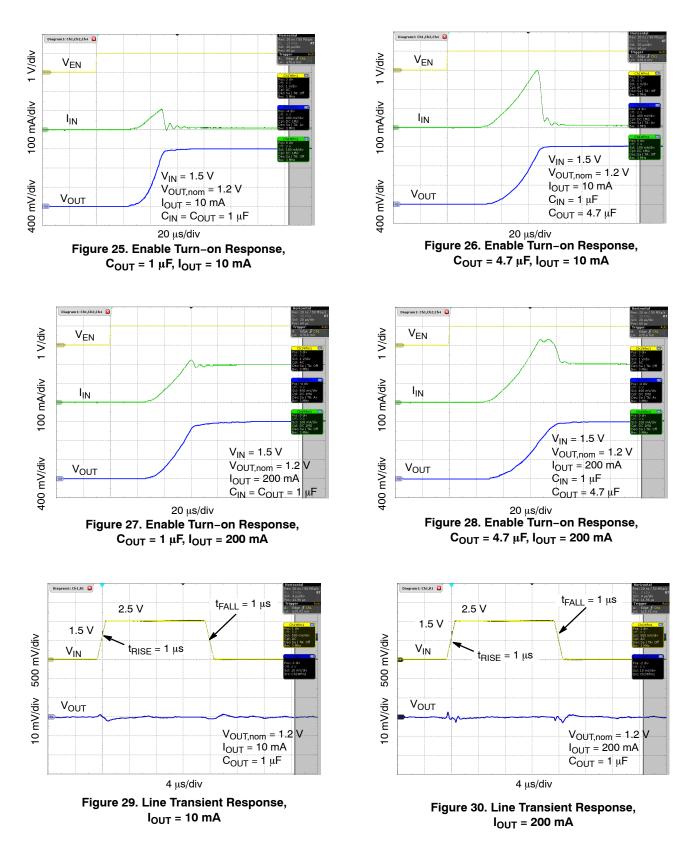
| lout | RMS Output Noise (µV) | | | |
|------|-----------------------|------------------|--|--|
| (mA) | 10 Hz – 100 kHz | 100 Hz – 100 kHz | | |
| 2 | 10.01 | 8.79 | | |
| 20 | 8.78 | 7.39 | | |
| 200 | 8.77 | 7.44 | | |

| lout | RMS Output Noise (µV) | | | |
|------|-----------------------|------------------|--|--|
| (mA) | 10 Hz – 100 kHz | 100 Hz – 100 kHz | | |
| 2 | 9.88 | 8.71 | | |
| 20 | 9.01 | 7.73 | | |
| 200 | 9.08 | 7.70 | | |



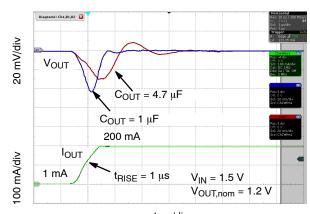


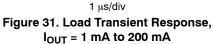
TYPICAL CHARACTERISTICS

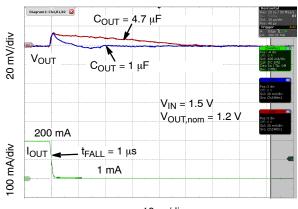


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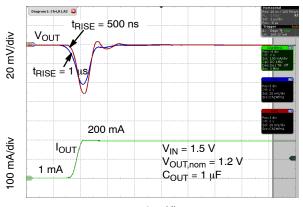
TYPICAL CHARACTERISTICS







 $\begin{array}{l} 10 \ \mu \text{s/div} \\ \text{Figure 32. Load Transient Response,} \\ I_{OUT} = 1 \ \text{mA to 200 mA} \end{array}$



1 μs/div

Figure 33. Load Transient Response, I_{OUT} = 1 mA to 200 mA

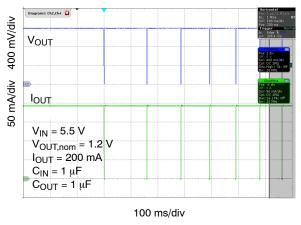
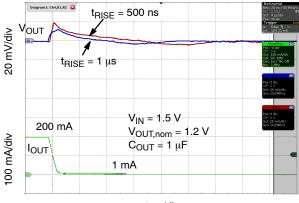


Figure 35. Overheating Protection – TSD



4 μs/div

Figure 34. Load Transient Response, I_{OUT} = 1 mA to 200 mA

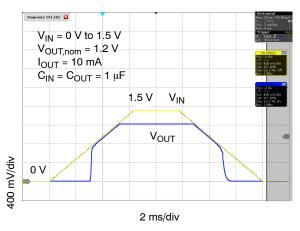


Figure 36. Turn On/Off, Slow Rising VIN

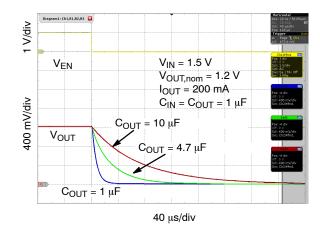


Figure 37. Enable Turn-off Response, Various Output Capacitors

APPLICATIONS INFORMATION

General

The NCP110 is an ultra-low input voltage, ultra-low noise 200 mA low dropout regulator designed to meet the requirements of low voltage RF applications and high performance analog circuits. The NCP110 device provides very high PSRR and excellent dynamic response. In connection with low quiescent current this device is well suitable for battery powered application such as cell phones, tablets and other. The NCP110 is fully protected in case of current overload, output short circuit and overheating.

Input Capacitor Selection (CIN)

Input capacitor connected as close as possible is necessary for ensure device stability. The X7R or X5R capacitor should be used for reliable performance over temperature range. The value of the input capacitor should be 1 μ F or greater to ensure the best dynamic performance. This capacitor will provide a low impedance path for unwanted AC signals or noise modulated onto constant input voltage. There is no requirement for the ESR of the input capacitor but it is recommended to use ceramic capacitors for their low ESR and ESL. A good input capacitor will limit the influence of input trace inductance and source resistance during sudden load current changes.

Output decoupling

The NCP110 requires an output capacitor connected as close as possible to the output pin of the regulator. The recommended capacitor value is 1μ F and X7R or X5R dielectric due to its low capacitance variations over the specified temperature range. The NCP110 is designed to remain stable with minimum effective capacitance of 0.6μ F to account for changes with temperature, DC bias and package size. Especially for small package size capacitors such as 0201 the effective capacitance drops rapidly with the applied DC bias. Please refer to Figure 38.

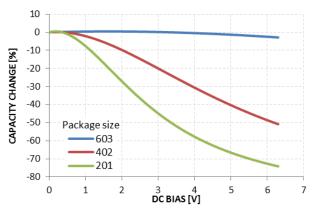


Figure 38. Capacity vs DC Bias Voltage

There is no requirement for the minimum value of Equivalent Series Resistance (ESR) for the C_{OUT} but the maximum value of ESR should be less than 1.6 Ω . Larger

output capacitors and lower ESR could improve the load transient response or high frequency PSRR. It is not recommended to use tantalum capacitors on the output due to their large ESR. The equivalent series resistance of tantalum capacitors is also strongly dependent on the temperature, increasing at low temperature.

Enable Operation

The NCP110 uses the EN pin to enable/disable its device and to deactivate/activate the active discharge function. If the EN pin voltage is <0.2 V the device is guaranteed to be disabled. The pass transistor is turned–off so that there is virtually no current flow between the IN and OUT. The active discharge transistor is active so that the output voltage V_{OUT} is pulled to GND through a 280 Ω resistor. In the disable state the device consumes as low as typ. 10 nA from the V_{IN}. If the EN pin voltage >0.7 V the device is guaranteed to be enabled. The NCP110 regulates the output voltage and the active discharge transistor is turned–off. The EN pin has internal pull–down current source with typ. value of 200 nA which assures that the device is turned–off when the EN pin is not connected. In the case where the EN function isn't required the EN should be tied directly to IN.

Output Current Limit

Output Current is internally limited within the IC to a typical 350 mA. The NCP110 will source this amount of current measured with a voltage drops on the 90% of the nominal V_{OUT} . If the Output Voltage is directly shorted to ground ($V_{OUT} = 0$ V), the short circuit protection will limit the output current to 360 mA (typ). The current limit and short circuit protection will work properly over whole temperature range and also input voltage range. There is no limitation for the short circuit duration.

Thermal Shutdown

When the die temperature exceeds the Thermal Shutdown threshold (TSD – 160° C typical), Thermal Shutdown event is detected and the device is disabled. The IC will remain in this state until the die temperature decreases below the Thermal Shutdown Reset threshold (TSDU – 140° C typical). Once the IC temperature falls below the 140°C the LDO is enabled again. The thermal shutdown feature provides the protection from a catastrophic device failure due to accidental overheating. This protection is not intended to be used as a substitute for proper heat sinking.

Power Dissipation

As power dissipated in the NCP110 increases, it might become necessary to provide some thermal relief. The maximum power dissipation supported by the device is dependent upon board design and layout. Mounting pad configuration on the PCB, the board material, and the ambient temperature affect the rate of junction temperature rise for the part. The maximum power dissipation the NCP110 can handle is given by:

The power dissipated by the NCP110 for given application conditions can be calculated from the following equations:

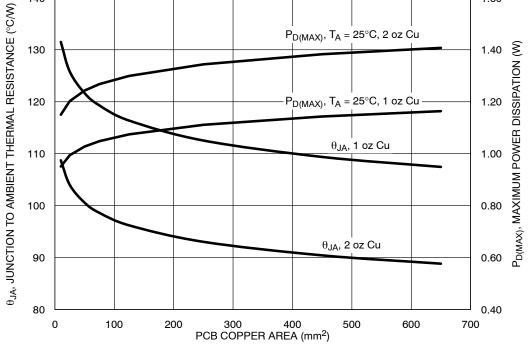
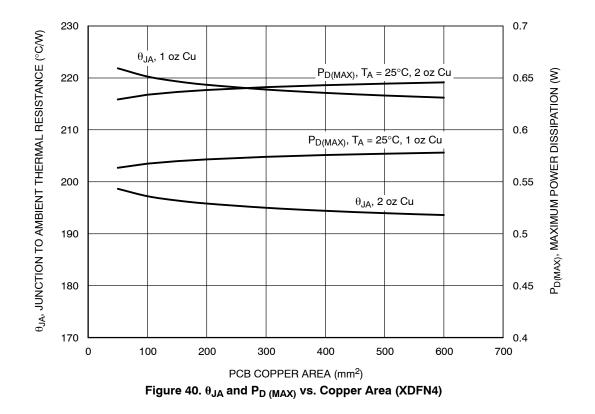


Figure 39. θ_{JA} and P_{D (MAX)} vs. Copper Area (CSP4)



ORDERING INFORMATION

| Device | Nominal Output Voltage | Marking | Rotation | Description | Package | Shipping [†] |
|------------------|------------------------------|---------|----------|--------------------------|------------|-----------------------|
| NCP110AFCT060T2G | 0.60 V | C | 0° | • | | |
| NCP110AFCT080T2G | 0.80 V | J | 0° | | | |
| NCP110AFCT085T2G | 0.85 V | 2 | 0° | | | |
| NCP110AFCT100T2G | 1.00 V | Т | 0° | | WLCSP4 | 5000 / |
| NCP110AFCT105T2G | 1.05 V | Ā | 0° | 200 mA, Active Discharge | CASE 567VS | Tape & |
| NCP110AFCT110T2G | 1.10 V | G | 0° | | (Pb-Free) | Reel |
| NCP110AFCT120T2G | 1.20 V | F | 0° | | | |
| NCP110AFCT180T2G | 1.80 V | D | 0° | | | |
| NCP110AFCT280T2G | 2.80 V | E | 0° | | | |

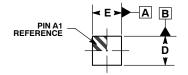
ORDERING INFORMATION

| Device | Nominal Output Voltage | Marking | Description | Package | Shipping |
|-----------------|------------------------|---------|--------------------------|----------------------------------|--------------------------|
| NCP110AMX060TBG | 0.60 V | FC | | | |
| NCP110AMX075TBG | 0.75 V | F3 | | | |
| NCP110AMX080TBG | 0.80 V | FJ | | | |
| NCP110AMX085TBG | 0.85 V | F2 | 200 mA, Active Discharge | XDFN4 CASE 711AJ (Pb-Free) | 3000 / Tape & Reel |
| NCP110AMX100TBG | 1.00 V | FG | | | |
| NCP110AMX105TBG | 1.05 V | FA | | | |
| NCP110AMX110TBG | 1.10 V | FH | | | |
| NCP110AMX120TBG | 1.20 V | FF | | | |
| NCP110AMX180TBG | 1.80 V | FD | | | |
| NCP110AMX280TBG | 2.80 V | FE | | | |

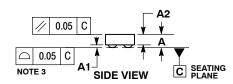
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

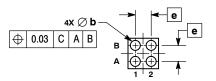


SCALE 4:1



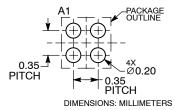




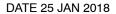


BOTTOM VIEW

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

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| | MI | LLIMETE | RS | | | |
|-----|-------------------|----------|-------|--|--|--|
| DIM | MIN | NOM | MAX | | | |
| Α | | | 0.33 | | | |
| A1 | 0.04 | 0.06 | 0.08 | | | |
| A2 | | 0.23 REF | | | | |
| b | 0.180 | 0.200 | 0.220 | | | |
| D | 0.610 | 0.640 | 0.670 | | | |
| Е | 0.610 0.640 0.670 | | | | | |
| е | 0.35 BSC | | | | | |





X = Specific Device Code M = Month

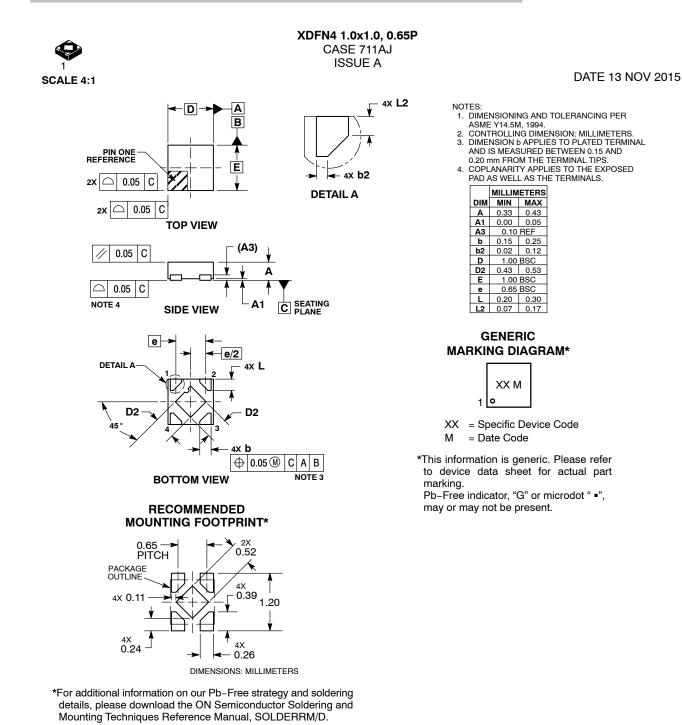
*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot " ■", may or may not be present. Some products may not follow the Generic Marking.

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WLCSP4, 0.64x0.64x0.33

CASE 567VS ISSUE O





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| DESCRIPTION: | XDFN4, 1.0X1.0, 0.65P | | PAGE 1 OF 1 |
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